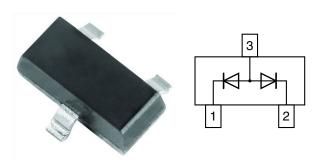


# Vishay Semiconductors

# **Small Signal Switching Diode, Dual**



#### **LINKS TO ADDITIONAL RESOURCES**











#### **FEATURES**

- Silicon epitaxial planar diode
- · Fast switching dual diode with common anode
- AEC-Q101 qualified available
- Molding compound meets UL 94 V-0 flammability rating
- Moisture sensitivity level (MSL) 1
- Base P/N-E3 RoHS-compliant, commercial grade
- Base P/N-HE3\_A RoHS-compliant, AEC-Q101 qualified
- · Material categorization: for definitions of compliance please see www.vishav.com/doc?99912







RoHS COMPLIANT

#### **MECHANICAL DATA**

Case: SOT-23

Weight: approx. 9.2 mg Packaging codes / options:

18/10K per 13" reel (8 mm tape), 10K/box 08/3K per 7" reel (8 mm tape), 15K/box

PARTS TABLE							
PART	ORDERING CODE	AEC-Q101 QUALIFIED	TYPE MARKING	CIRCUIT CONFIGURATION	TAPED UNITS PER REEL	MINIMUM ORDER QUANTITY	
	BAW56-E3-08	no	JDG	Common anode	3 000	15 000	
BAW56	BAW56-HE3_A-08	yes			(8 mm tape on 7" reel)	15 000	
BAWSO	BAW56-E3-18	no			10 000	10 000	
	BAW56-HE3_A-18	yes			(8 mm tape on 13" reel)	10 000	

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Repetitive peak reverse voltage = working peak reverse voltage = DC blocking voltage		$V_R = V_{RRM}$	70	V	
Forward continuous current (1)		I <sub>F</sub>	350	mA	
Non repetitive peak forward current (1)	t <sub>p</sub> = 1 μs	I <sub>FSM</sub>	2	А	
	t <sub>p</sub> = 1 ms	I <sub>FSM</sub>	1		
	t <sub>p</sub> = 1 s	I <sub>FSM</sub>	0.5		
Power dissipation	on FR-4 board with recommended soldering footprint	В	270	mW	
Power dissipation	Infinite heatsink	P <sub>tot</sub> 390		11100	

#### Note

(1) Infinite heatsink

THERMAL CHARACTERISTICS (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Thermal resistance junction to ambient air	according to JEDEC® 51-3 on FR-4 board with recommended soldering footprint	R <sub>thJA</sub>	460	K/W	
Thermal resistance junction to lead	Infinite heatsink	R <sub>thJL</sub>	320	K/W	
Junction temperature		Tj	150	°C	
Storage temperature range		T <sub>stg</sub>	-65 to +150	°C	
Operating temperature range		T <sub>op</sub>	-55 to +150	°C	

# Vishay Semiconductors

<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	MAX.	UNIT	
	I <sub>F</sub> = 1 mA	V <sub>F</sub>	0.715	V	
Forward voltage	I <sub>F</sub> = 10 mA	$V_{F}$	0.855	V	
Forward voltage	I <sub>F</sub> = 50 mA	V <sub>F</sub>	1	V	
	I <sub>F</sub> = 150 mA	V <sub>F</sub>	1 1.25 100	V	
	V <sub>R</sub> = 70 V	I <sub>R</sub>	100	nA	
Reverse current	V <sub>R</sub> = 70 V, T <sub>j</sub> = 150 °C	I <sub>R</sub>	100	μΑ	
	V <sub>R</sub> = 25 V, T <sub>j</sub> = 150 °C	SYMBOL         MAX.           VF         0.715           VF         0.855           VF         1           VF         1.25           IR         100	μΑ		
Diode capacitance	$V_F = V_R = 0 \text{ V}, f = 1 \text{ MHz}$	C <sub>D</sub>	1.5	pF	
Reverse recovery time	$I_F$ = 10 mA to $I_R$ = 1 mA, $V_R$ = 6 V, $R_L$ = 100 $\Omega$	t <sub>rr</sub>	6	ns	

### **TYPICAL CHARACTERISICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)

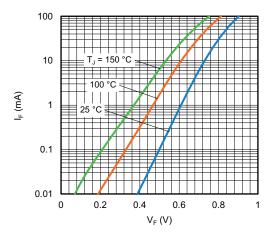


Fig. 1 - Forward Current vs. Forward Voltage

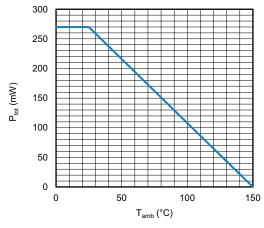


Fig. 2 - Admissible Power Dissipation vs. Ambient Temperature

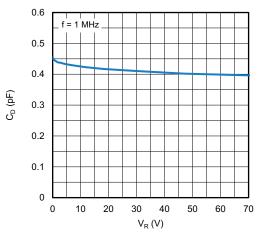


Fig. 3 - Typical Capacitance vs. Reverse Voltage

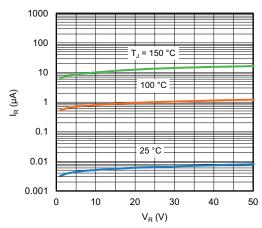
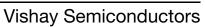
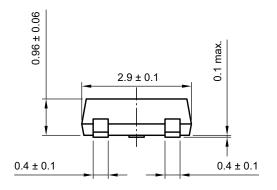


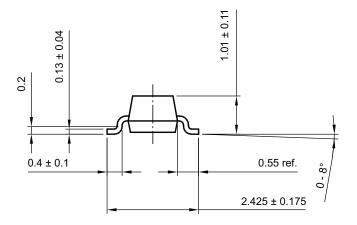
Fig. 4 - Typical Reverse Leakage Current vs. Reverse Voltage

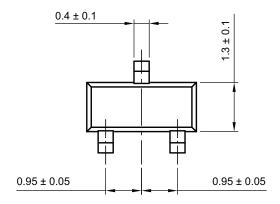




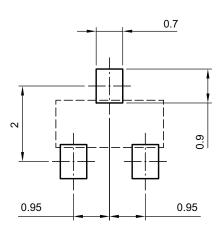
#### **PACKAGE DIMENSIONS** in millimeters: **SOT-23**







#### footprint recommendation:



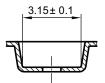
Created - Date: 18-Oct-2021 Rev. 01 - Date: 18-Jan-2022 S8-V-3929.01-009 (4)

# Vishay Semiconductors

#### **CARRIER TAPE SOT-23**

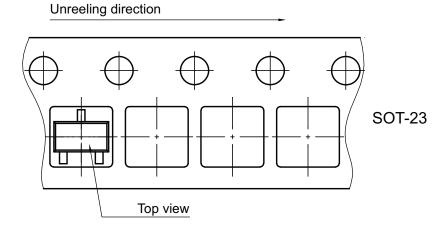
# A-A Section 0.229 ± 0.013 0.229 ± 0.013 0.229 ± 0.013 0.229 ± 0.013 0.229 ± 0.013

**B-B Section** 



Created Date: 04-Feb-2010 Rev. Date: 07-Feb-2022 S8-V-3929.01-005 (4)

#### **ORIENTATION IN CARRIER TAPE SOT-23**



Created Date: 04-Feb-2010 Rev. Date: 07-Nov-2022 S8-V-3929.01-005 (4)



# **Legal Disclaimer Notice**

Vishay

## **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.